

INVENTOR INFORMATION

Inventor One Given Name:: Chi Wah
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CORRESPONDENCE INFORMATION

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APPLICATION INFORMATION

Title Line One:: APPARATUS AND METHOD OF PLACING SOLDER B
Title Line Two:: ALLS ONTO A SUBSTRATE
Total Drawing Sheets:: 5
Formal Drawings?: Yes
Application Type:: Utility
Docket Number:: P/4076-10
Secrecy Order in Parent Appl.?: No

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